ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan	C, Bannockb	ourn, Illinois. A	Ill rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the s encompasse	ubstances es all lowe	within the m r level mater	nanufacture ials for wh	er listed ite nich the ma	n. Note: nufacture	if the item is an as r has engineering	ssembly with low responsibility.
	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Inf					Informat	tion		
upplier Information														
Company name* Company			npany unique ID			Unique ID Authority					Response Date*			
onsemi											2024-05-20			
Distant Name Title - Contact						Phone - Contact*					Email - Contact*			
Product-Env-Stewards Product Enviro			viro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Representative			sentative	ive P		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product Enviro Compli			ro Compliance	Compliance N			NA				Product-Env-Stewards@onsemi.com			
Requester Item Number	uester Item Number Mfr Item Numb		Number Mfr Item Name			Effective Dat	e Version		Manufacturing Site		W	eight*	UOM	Unit Type
	FPF2195	PF2195BUCX Current Limit Loa		ad Switch		2024-05-20		:	РВВ		1.	8825	mg	Each
Ianufacturing Proccess Informat	ion										·		·	
Terminal Plating / Grid Array Material Terminal Base Alloy			Alloy	J-STD-020 MS	D-020 MSL Rating Peak Process Body Temp					e at Peak	Temperatu	e Num	ber of Reflow Cy	cles
SnAgCu CU Alloy 1			1		260		С	30		seconds	3			
omments														
vel 1 - maximum time at peak temperatu	re during sol	ldering is 10-3	0 seconds											
r more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

	cable [E] enter the weigh			ance category (JIG or Requester) or [F] Optionally enter the positive (+				
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.7416	mg	Supplier	Silicon (Si)	7440-21-3		0.7416	mg
Protection coat	0.0044	mg		Polyimide	proprietary data		0.0044	mg
Solder Ball	0.6236	mg	Supplier	Silver (Ag)	7440-22-4		0.0249	mg
			Supplier	Tin (Sn)	7440-31-5		0.5955	mg
			Supplier	Copper (Cu)	7440-50-8		0.0031	mg
UBM Sputter	3.0E-4	mg	Supplier	Titanium (Ti)	7440-32-6		0	mg
			Supplier	Copper (Cu)	7440-50-8		0.0003	mg
Under Bump Metal	0.0126	mg	Supplier	Copper (Cu)	7440-50-8		0.0126	mg